

Electronic Patent Application Fee Transmittal

| Application Number: | 10567337 | | | |
|---|--|----------|--------|----------------------|
| Filing Date: | 11-Sep-2006 | | | |
| Title of Invention: | MULTICHIP CIRCUIT MODULE AND METHOD FOR THE PRODUCTION THEREOF | | | |
| First Named Inventor/Applicant Name: | Johann Heyen | | | |
| Filer: | Michael E. Whitham/karen lumpkins | | | |
| Attorney Docket Number: | 03100278AA | | | |
| Filed as Large Entity | | | | |
| U.S. National Stage under 35 USC 371 Filing Fees | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Utility Appt Issue fee | 1501 | 1 | 1440 | 1440 |
| Publ. Fee- early, voluntary, or normal | 1504 | 1 | 300 | 300 |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-----------------------------------|----------|----------|--------|----------------------|
| Extension-of-Time: | | | | |
| Miscellaneous: | | | | |
| Printed copy of patent - no color | 8001 | 10 | 3 | 30 |
| Total in USD (\$) | | | | 1770 |